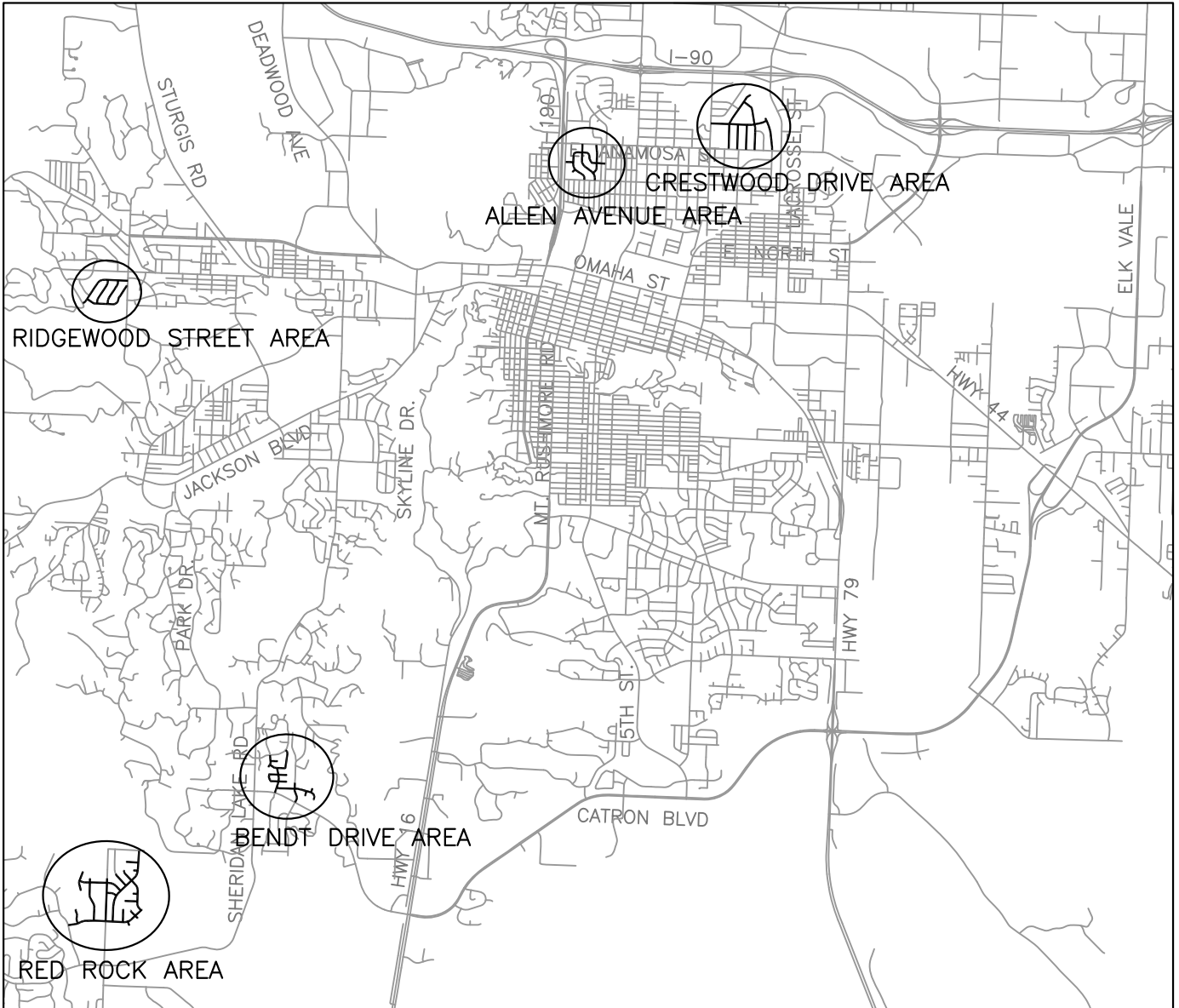


VICINITY MAP



**2017 CHIP SEALING PROJECT
PROJECT # 17-2379, CIP 50844**